

OP27A, OP27C LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL AMPLIFIERS

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- Replacements for ADI, PMI and LTC OP27 Series

Features of OP27A and OP27C:

- Maximum Equivalent Input Noise Voltage:
3.8 nV/ $\sqrt{\text{Hz}}$ at 1 kHz
5.5 nV/ $\sqrt{\text{Hz}}$ at 10 kHz
- Very Low Peak-to-Peak Noise Voltage at 0.1 Hz to 10 Hz . . . 80 nV Typ
- Low Input Offset Voltage
OP27A . . . 25 μV Max
OP27C . . . 100 μV Max
- High Voltage Amplification
OP27A . . . 1 V/ μV Min
OP27C . . . 0.7 V/ μV Min

description

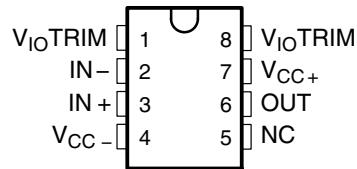
The OP27 operational amplifiers combine outstanding noise performance with excellent precision and high-speed specifications. The wideband noise is only 3 nV/ $\sqrt{\text{Hz}}$ and with the 1/f noise corner at 2.7 Hz, low noise is maintained for all low-frequency applications.

The outstanding characteristics of the OP27 make these devices excellent choices for low-noise amplifier applications requiring precision performance and reliability.

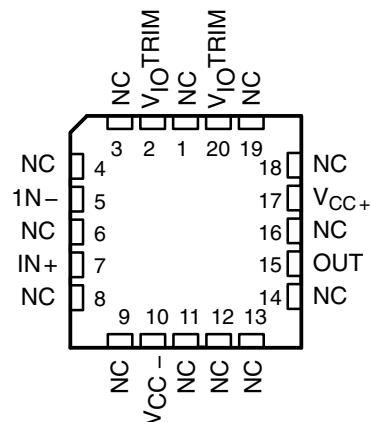
The OP27 series is compensated for unity gain.

The OP27A and OP27C are characterized for operation over the full military temperature range of -55°C to 125°C .

JG PACKAGE (TOP VIEW)

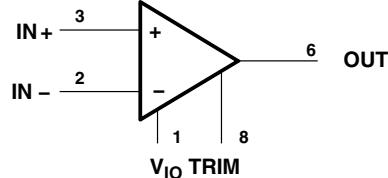


FK PACKAGE (TOP VIEW)



NC – No internal connection

symbol



Pin numbers are for the JG packages.

AVAILABLE OPTIONS

TA	V _{IO} _{max} AT 25°C	STABLE GAIN	PACKAGE	
			CERAMIC DIP (JG)	CHIP CARRIER (FK)
-55°C to 125°C	25 μV	1	OP27AJG	OP27AFK
	100 μV	1	OP27CJG	—



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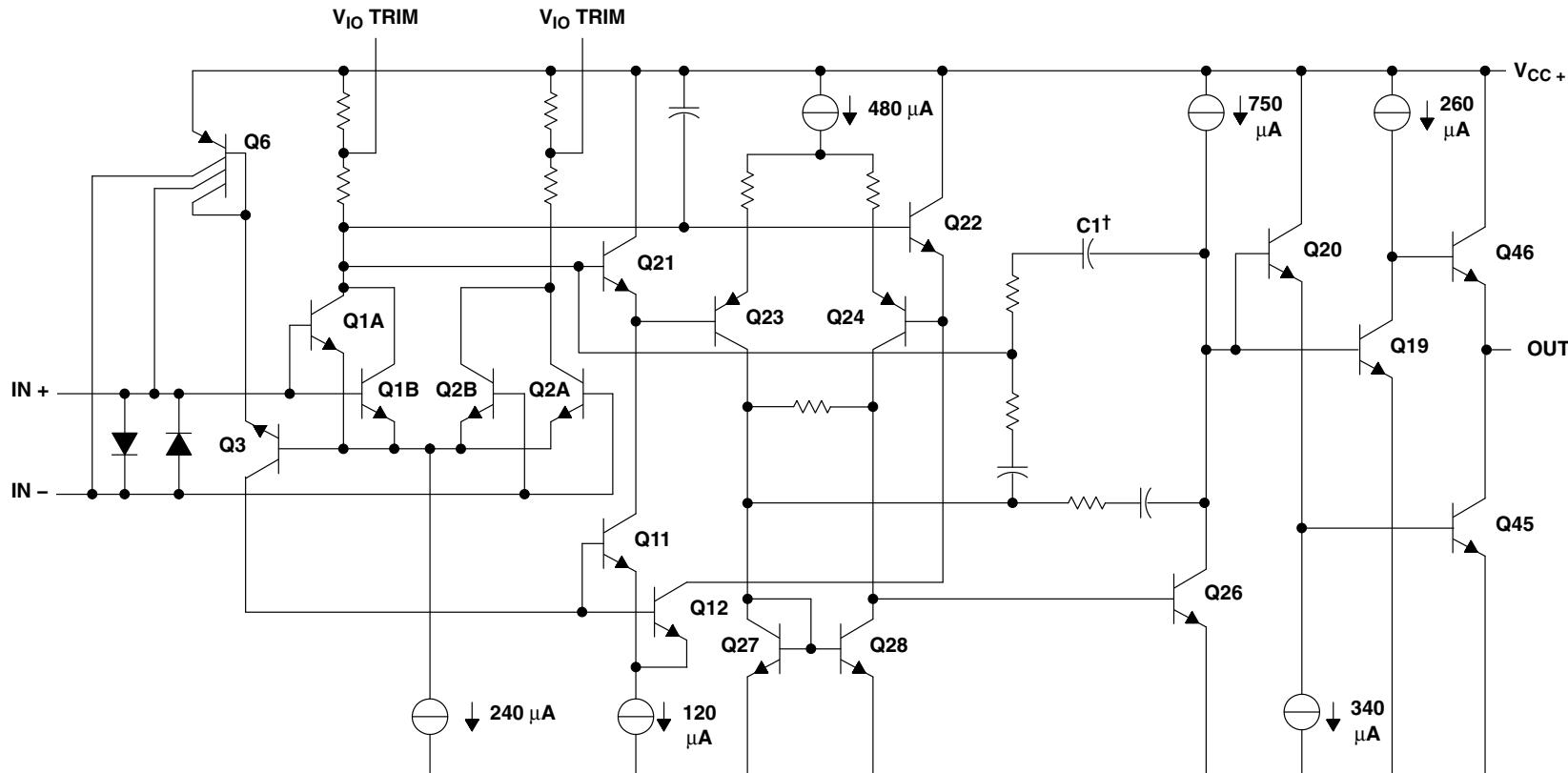


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OP27A, OP27C LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL-AMPLIFIER

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schematic



[†] C1 = 120 pF for OP27

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC+} (see Note 1)	22 V
Supply voltage, V_{CC-} (see Note 1)	22 V
Input voltage, V_I	$V_{CC\pm}$
Duration of output short circuit	unlimited
Differential input current (see Note 2)	± 25 mA
Continuous power dissipation	See Dissipation Rating Table
Operating free-air temperature range: OP27A, OP27C	-55°C to 125°C
Storage temperature range	-65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 60 seconds: JG or FK package	300°C

NOTES: 1. All voltage values are with respect to the midpoint between V_{CC+} and V_{CC-} unless otherwise noted.
2. The inputs are protected by back-to-back diodes. Current-limiting resistors are not used in order to achieve low noise. Excessive input current will flow if a differential input voltage in excess of approximately ± 0.7 V is applied between the inputs unless some limiting resistance is used.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 85^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
JG	1050 mW	8.4 mW/°C	546 mW	210 mW
FK	1375 mW	11.0 mW/°C	715 mW	275 mW

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recommended operating conditions

	OP27A			OP27C			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC+}	4	15	22	4	15	22	V
Supply voltage, V_{CC-}	-4	-15	-22	-4	-15	-22	V
Common-mode input voltage, V_{IC}	$V_{CC\pm} = \pm 15$ V, $T_A = 25^\circ\text{C}$	± 11		± 11			V
	$V_{CC\pm} = \pm 15$ V, $T_A = -55^\circ\text{C}$ to 125°C	± 10.3		± 10.2			
Operating free-air temperature, T_A	-55		125	-55		125	°C

electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	OP27A			OP27C			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_O = 0$, $V_{IC} = 0$ $R_S = 50$ Ω, See Note 3	25°C	10	25		30	100		μV
		Full range		60			300		
α_{VIO} Average temperature coefficient of input offset voltage		Full range	0.2	0.6		0.4	1.8		μV/°C
Long-term drift of input offset voltage	See Note 4		0.2	1		0.4	2		μV/mo
I_{IO} Input offset current	$V_O = 0$, $V_{IC} = 0$	25°C	7	35		12	75		nA
		Full range		50			135		
I_{IB} Input bias current	$V_O = 0$, $V_{IC} = 0$	25°C	±10	±40		±15	±80		nA
		Full range		±60			±150		
V_{ICR} Common-mode input voltage range		25°C	11 to -11			11 to -11			V
		Full range	10.3 to -10.3			10.5 to -10.5			
V_{OM} Peak output voltage swing	$R_L \ge 2$ kΩ		±12	±13.8		±11.5	±13.5		V
	$R_L \ge 0.6$ kΩ		±10	±11.5		±10	±11.5		
	$R_L \ge 2$ kΩ	Full range	±11.5			10.5			
A_{VD} Large-signal differential voltage amplification	$R_L \ge 2$ kΩ, $V_O = \pm 10$ V		1000	1800		700	1500		V/mV
	$R_L \ge 1$ kΩ, $V_O = \pm 10$ V		800	1500			1500		
	$R_L \ge 0.6$ kΩ, $V_O = \pm 1$ V, $V_{CC\pm} = \pm 4$ V		250	700		200	500		
	$R_L \ge 2$ kΩ, $V_O = \pm 10$ V	Full range	600			300			
$r_{i(CM)}$ Common-mode input resistance				3			2		GeV
r_o Output resistance	$V_O = 0$, $I_O = 0$	25°C		70			70		Ω
CMRR Common-mode rejection ratio	$V_{IC} = \pm 11$ V	25°C	114	126		100	120		dB
	$V_{IC} = \pm 10$ V	Full range	110			94			
k_{SVR} Supply voltage rejection ratio	$V_{CC\pm} = \pm 4$ V to ± 18 V	25°C	100	120		94	118		dB
	$V_{CC\pm} = \pm 4.5$ V to ± 18 V	Full range	96			86			

† Full range is -55°C to 125°C .

NOTES: 3. Input offset voltage measurements are performed by automatic test equipment approximately 0.5 seconds after applying power.
4. Long-term drift of input offset voltage refers to the average trend line of offset voltage versus time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in V_{IO} during the first 30 days are typically 2.5 μV (see Figure 3).



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OP27 operating characteristics, $V_{CC\pm} = \pm 15$ V, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	OP27A			OP27C			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate $A_{VD} \geq 1$, $R_L \geq 2 \text{ k}\Omega$	1.7	2.8		1.7	2.8		V/ μ s
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage $f = 0.1$ Hz to 10 Hz, $R_S = 20 \Omega$, See Figure 26		0.225	0.375		0.225	0.375	μ V
V_n	Equivalent input noise voltage $f = 10$ Hz, $R_S = 20 \Omega$ $f = 1$ kHz, $R_S = 20 \Omega$		3.5	8		3.8	8	$\text{nV}/\sqrt{\text{Hz}}$
			3	4		3.2	4	
I_n	Equivalent input noise current $f = 10$ Hz, See Figure 27 $f = 1$ kHz, See Figure 27		5	25		5	25	$\text{pA}/\sqrt{\text{Hz}}$
			0.7	2.5		0.7	2.5	
Gain-bandwidth product		$f = 100$ kHz	5	8		5	8	MHz

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TYPICAL CHARACTERISTICS

Table of Graphs

		FIGURE
V_{IO}	Input offset voltage	vs Temperature 1
ΔV_{IO}	Change in input offset voltage	vs Time after power on 2 vs Time (long-term drift) 3
I_{IO}	Input offset current	vs Temperature 4
I_{IB}	Input bias current	vs Temperature 5
V_{ICR}	Common-mode input voltage range	vs Supply voltage 6
V_{OM}	Maximum peak output voltage	vs Load resistance 7
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency 8
AvD	Differential voltage amplification	vs Supply voltage 9
		vs Load resistance 10
		vs Frequency 11, 12
CMRR	Common-mode rejection ratio	vs Frequency 13
kSVR	Supply voltage rejection ratio	vs Frequency 14
SR	Slew rate	vs Temperature 15
ϕ_m	Phase margin	vs Temperature 16
ϕ	Phase shift	vs Frequency 11
V_n	Equivalent input noise voltage	vs Bandwidth 17
		vs Source resistance 18
		vs Supply voltage 19
		vs Temperature 20
		vs Frequency 21
Gain-bandwidth product		vs Temperature 16
I_{OS}	Short-circuit output current	vs Time 22
I_{CC}	Supply current	vs Supply voltage 23
Pulse response		Small signal 24 Large signal 25

TYPICAL CHARACTERISTICS

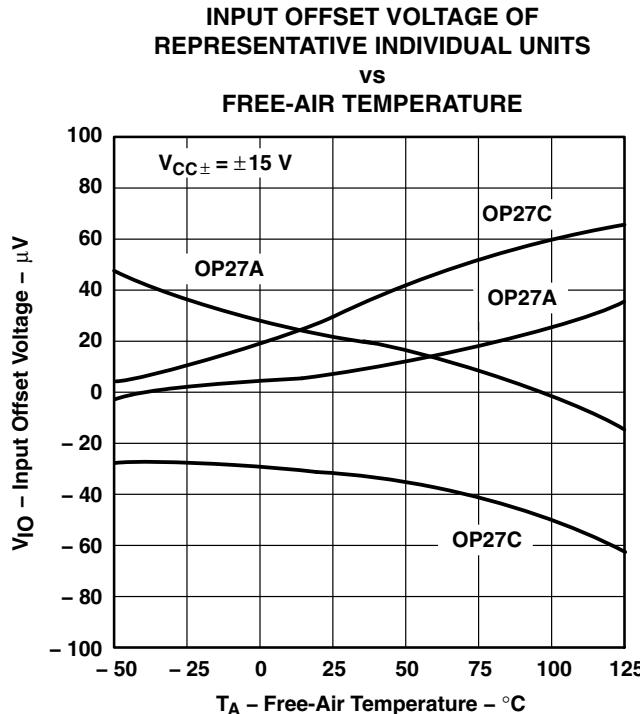


Figure 1

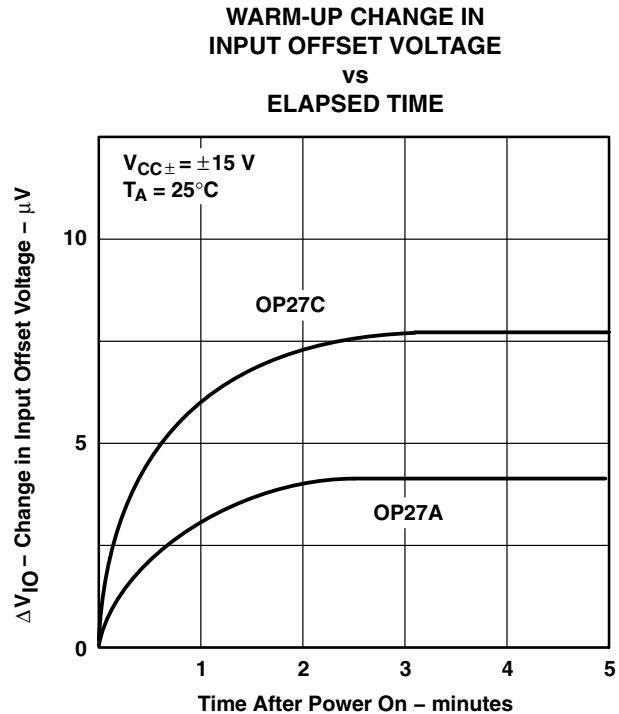


Figure 2

LONG-TERM DRIFT OF INPUT OFFSET VOLTAGE OF
REPRESENTATIVE INDIVIDUAL UNITS

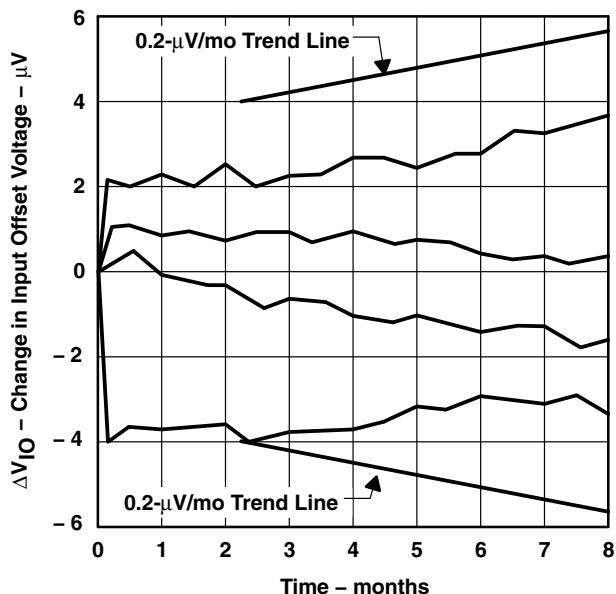


Figure 3

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TYPICAL CHARACTERISTICS

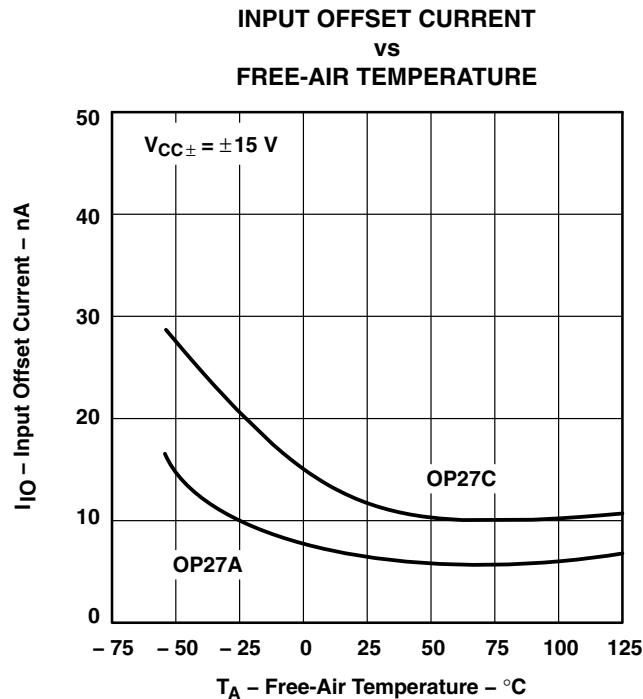


Figure 4

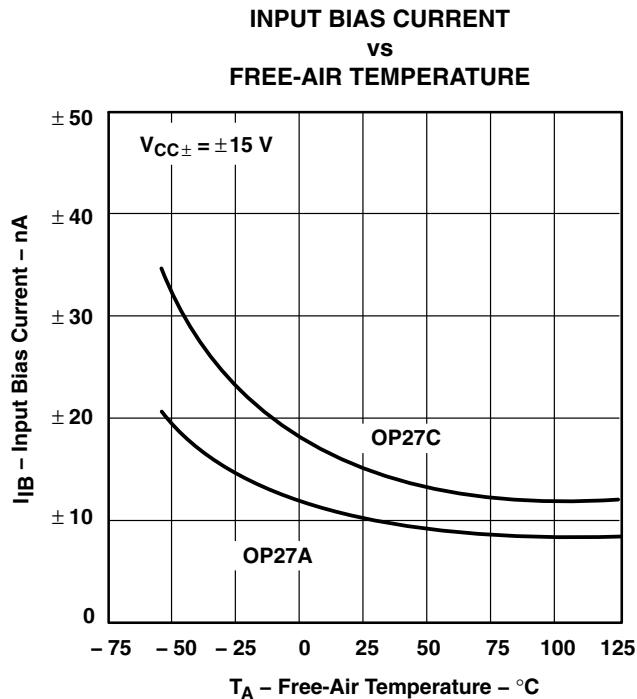


Figure 5

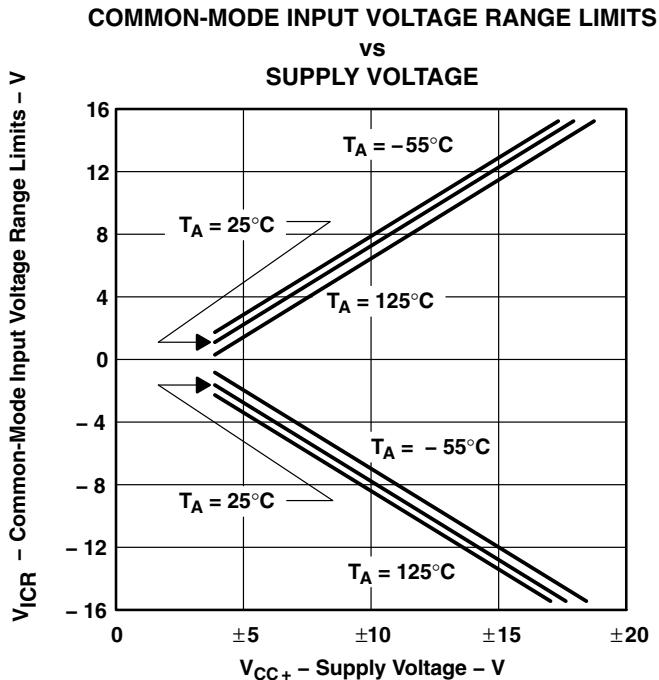


Figure 6

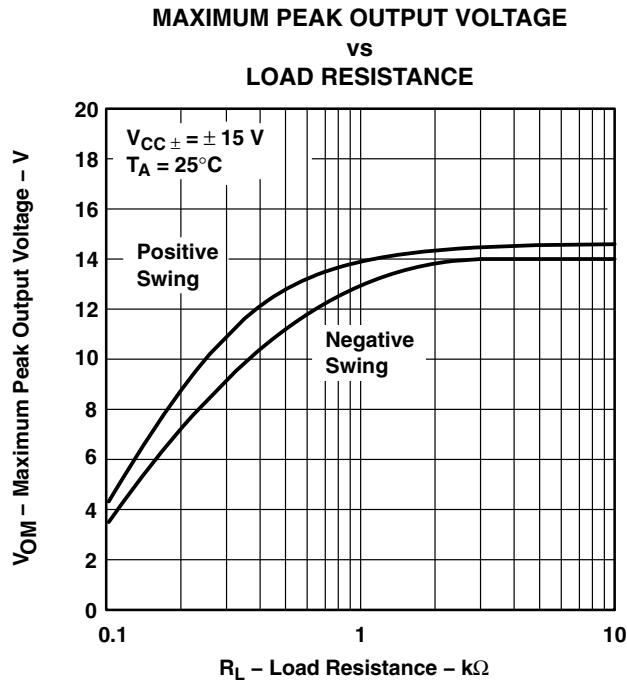


Figure 7

TYPICAL CHARACTERISTICS

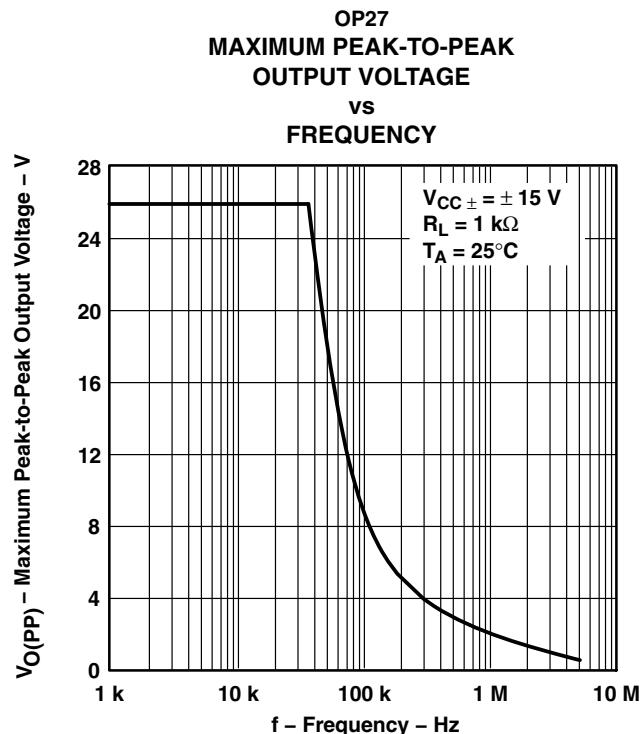


Figure 8.

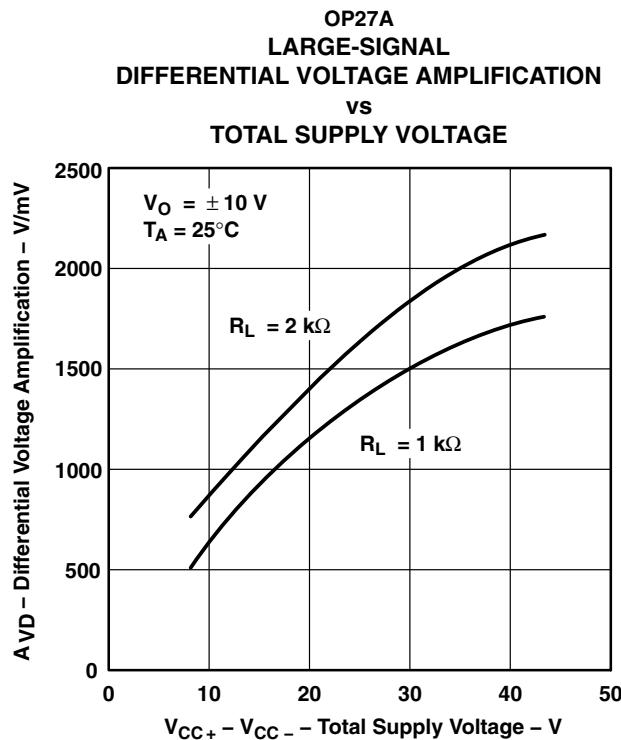


Figure 9

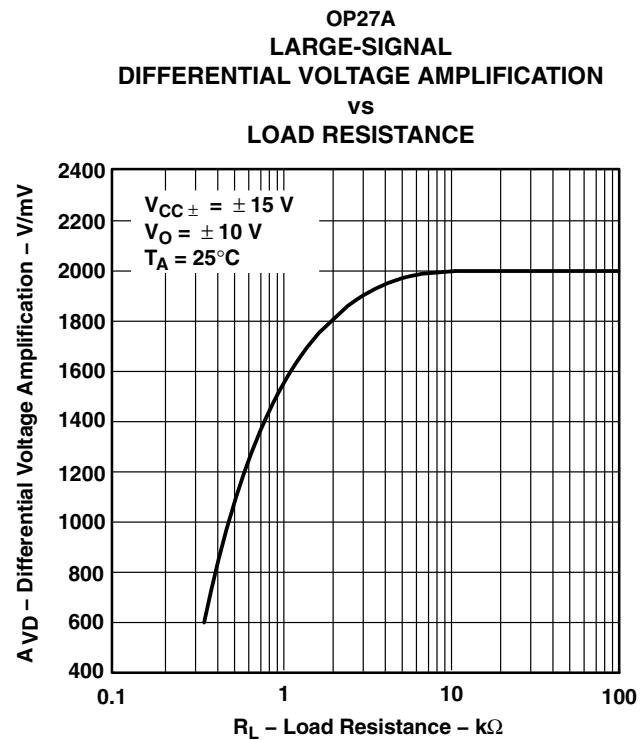


Figure 10

OP27A, OP27C LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL-AMPLIFIER

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TYPICAL CHARACTERISTICS

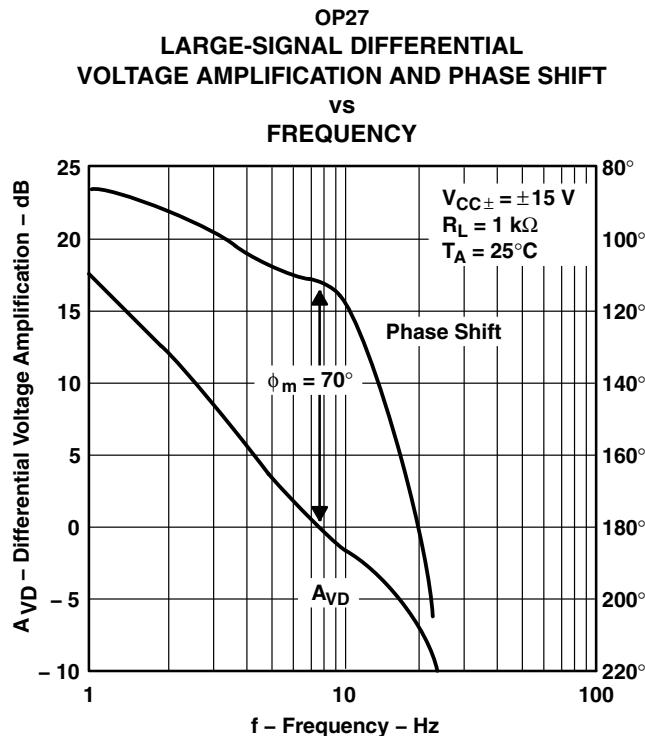


Figure 11.

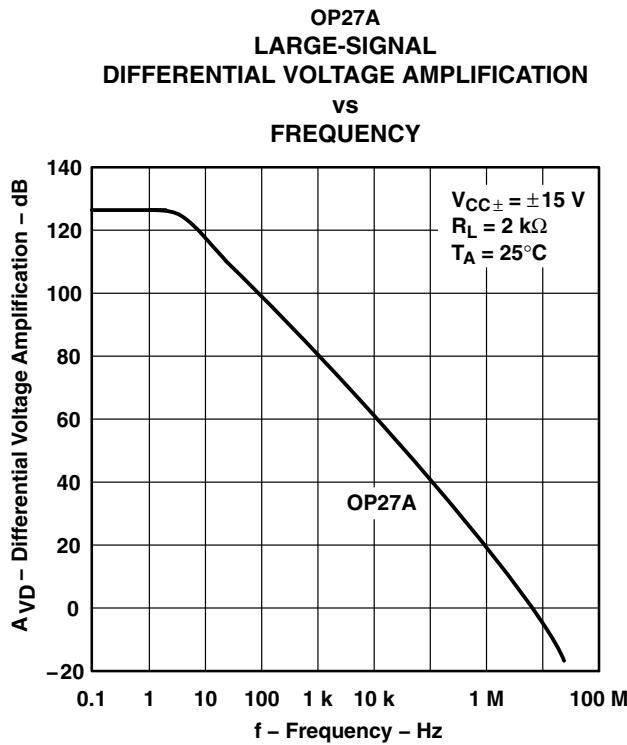


Figure 12

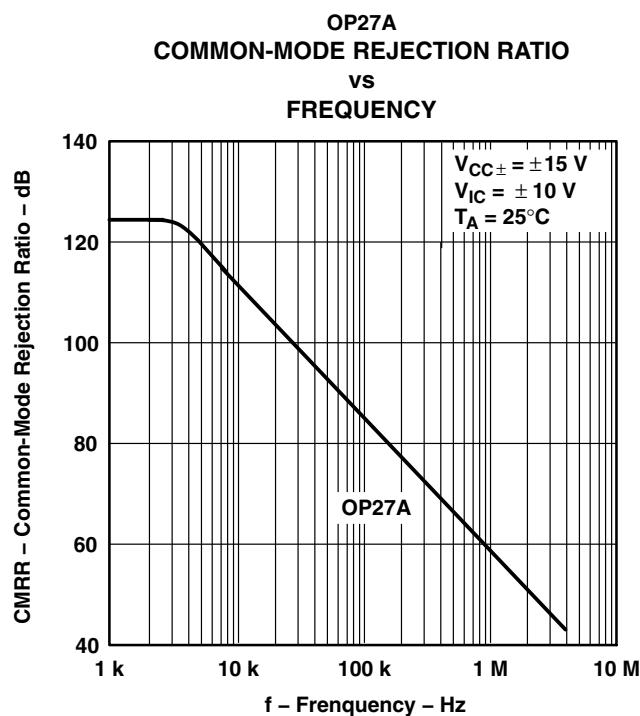


Figure 13

TYPICAL CHARACTERISTICS

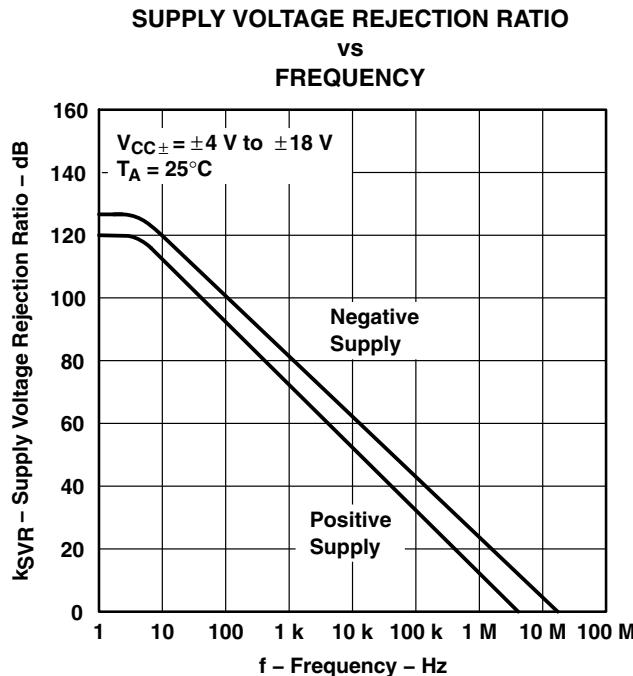


Figure 14

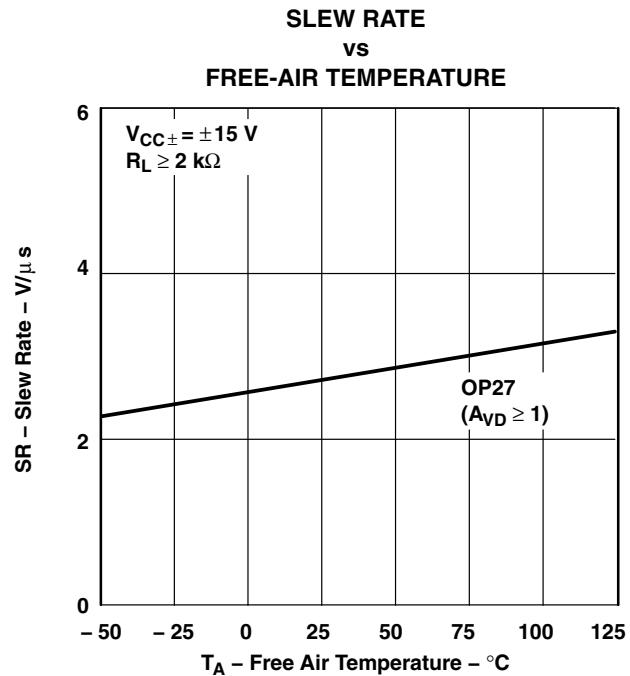


Figure 15

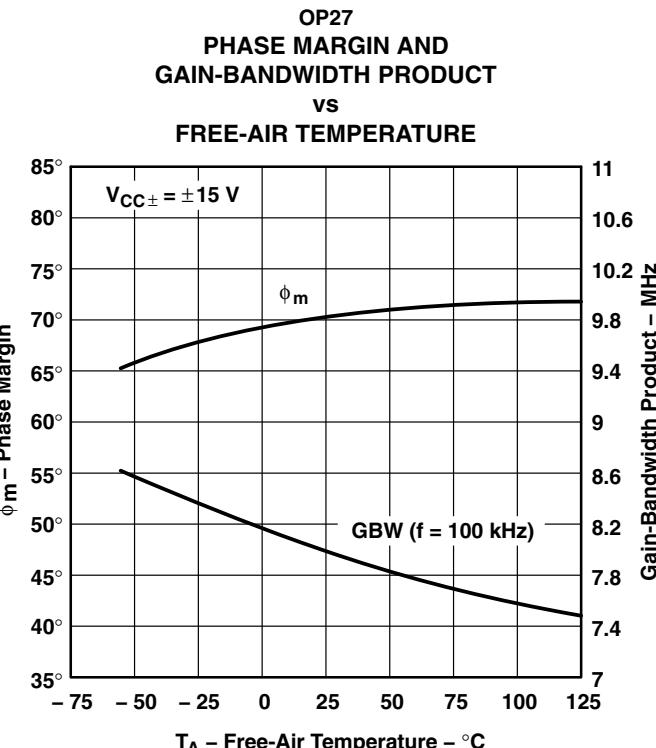


Figure 16.

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TYPICAL CHARACTERISTICS

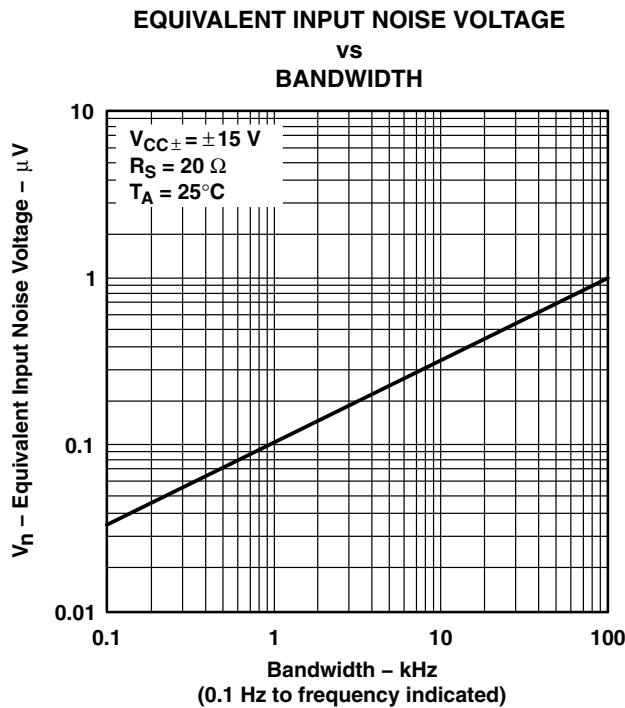


Figure 17

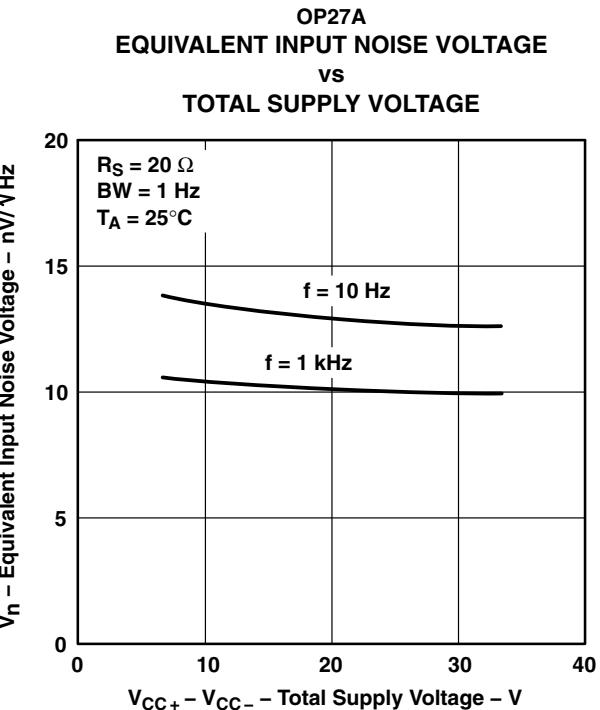


Figure 19

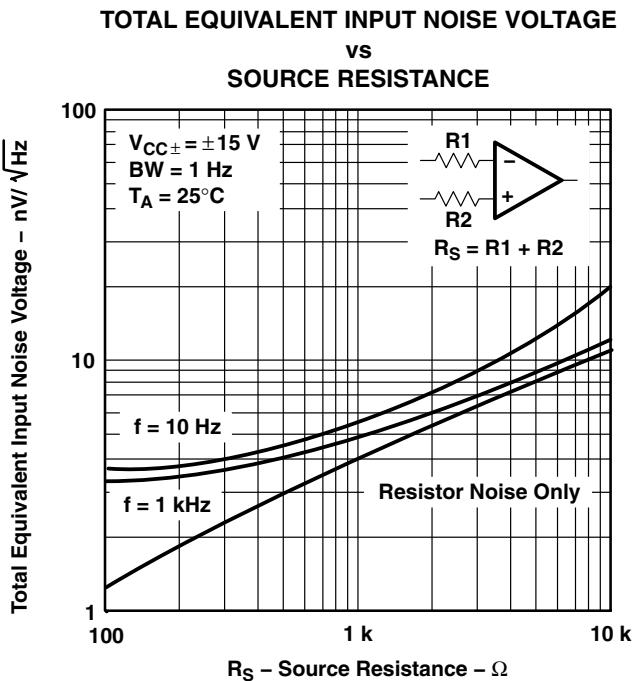


Figure 18

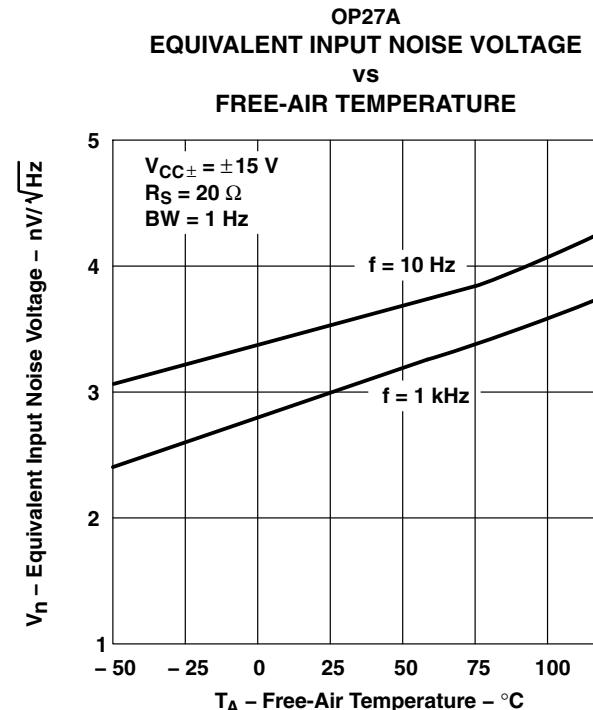


Figure 20

TYPICAL CHARACTERISTICS

OP27A
EQUIVALENT INPUT NOISE VOLTAGE
vs
FREQUENCY

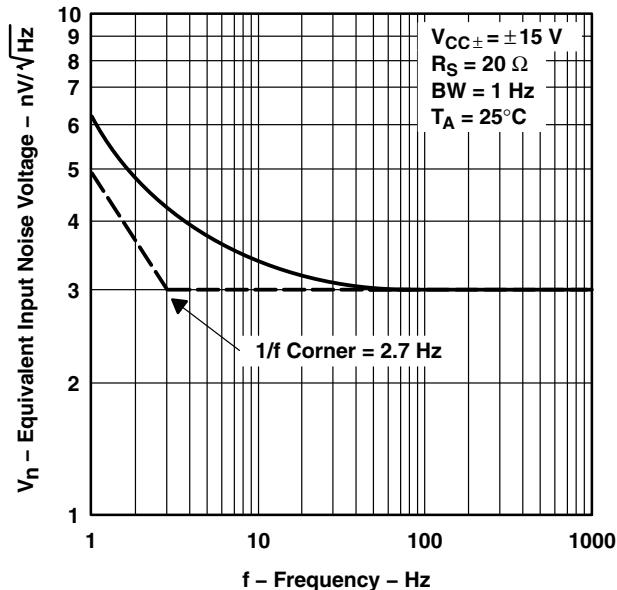


Figure 21

SHORT-CIRCUIT OUTPUT CURRENT
vs
ELAPSED TIME

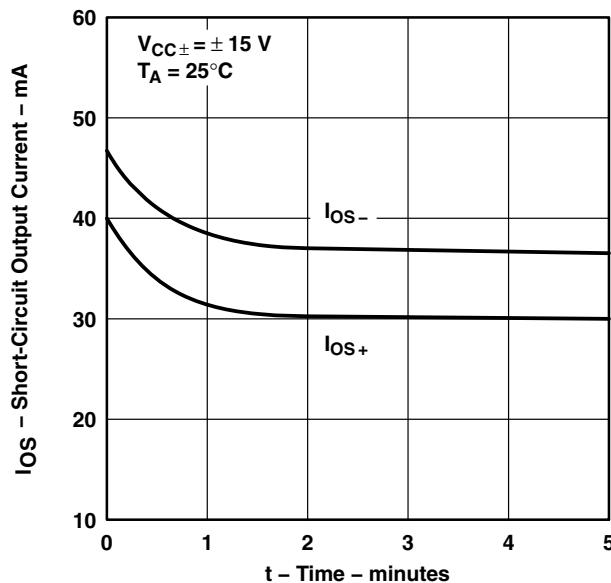


Figure 22

SUPPLY CURRENT
vs
TOTAL SUPPLY VOLTAGE

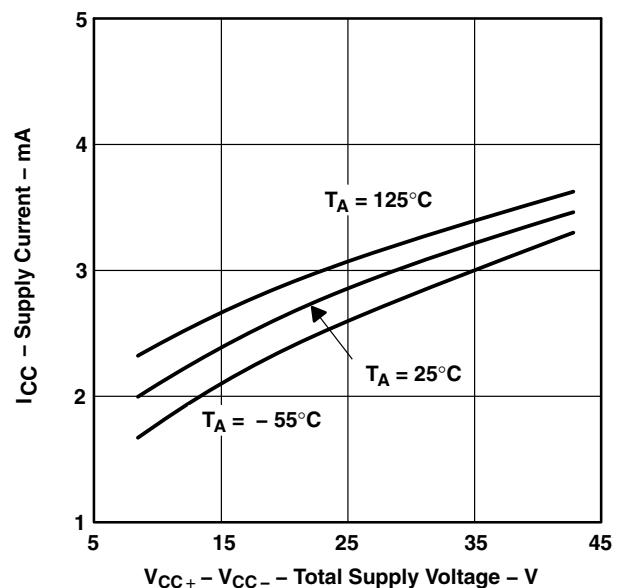


Figure 23

OP27A, OP27C LOW-NOISE HIGH-SPEED PRECISION OPERATIONAL-AMPLIFIER

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TYPICAL CHARACTERISTICS

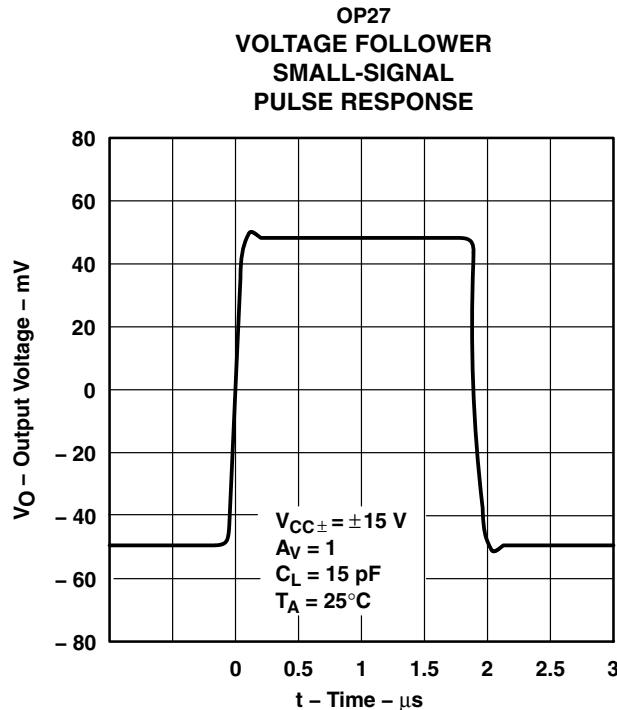


Figure 24

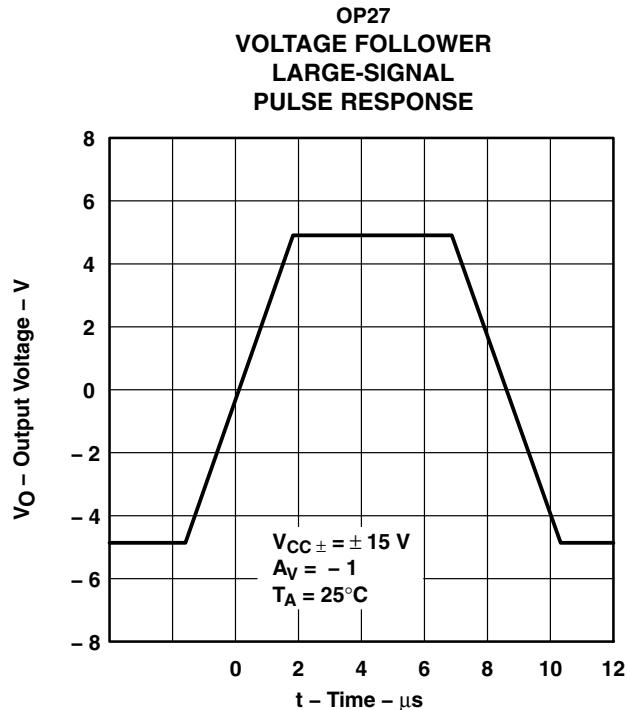


Figure 25

APPLICATION INFORMATION

general

The OP27 series devices can be inserted directly onto OP07, OP05, μ A725, and SE5534 sockets with or without removing external compensation or nulling components. In addition, the OP27 can be fitted to μ A741 sockets by removing or modifying external nulling components.

noise testing

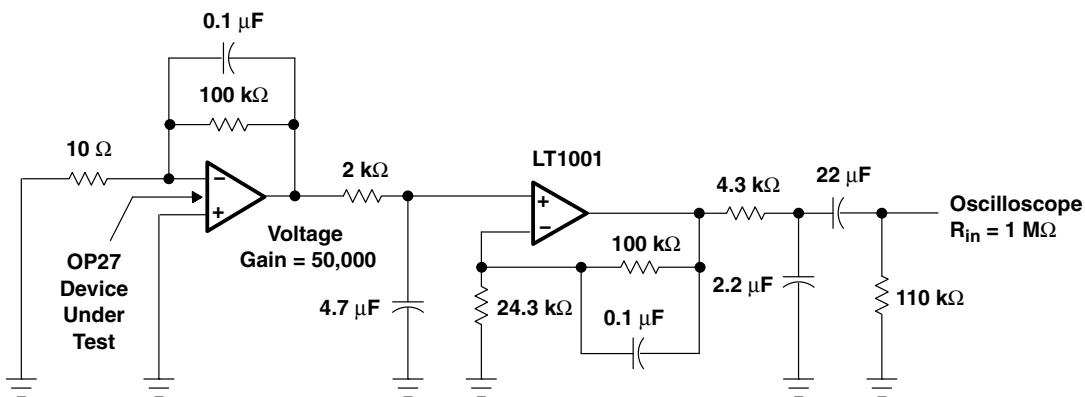
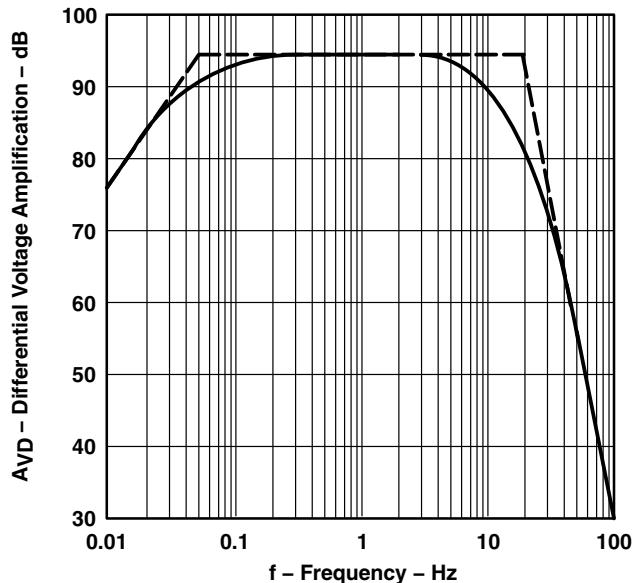
Figure 26 shows a test circuit for 0.1-Hz to 10-Hz peak-to-peak noise measurement of the OP27. The frequency response of this noise tester indicates that the 0.1-Hz corner is defined by only one zero. Because the time limit acts as an additional zero to eliminate noise contributions from the frequency band below 0.1 Hz, the test time to measure 0.1-Hz to 10-Hz noise should not exceed 10 seconds.

Measuring the typical 80-nV peak-to-peak noise performance of the OP27 requires the following special test precautions:

APPLICATION INFORMATION

noise testing (continued)

1. The device should be warmed up for at least five minutes. As the operational amplifier warms up, the offset voltage typically changes $4 \mu\text{V}$ due to the chip temperature increasing from 10°C to 20°C starting from the moment the power supplies are turned on. In the 10-s measurement interval, these temperature-induced effects can easily exceed tens of nanovolts.
2. For similar reasons, the device should be well shielded from air currents to eliminate the possibility of thermoelectric effects in excess of a few nanovolts, which would invalidate the measurements.
3. Sudden motion in the vicinity of the device should be avoided, as it produces a feedthrough effect that increases observed noise.



NOTE: All capacitor values are for nonpolarized capacitors only.

Figure 26. 0.1-Hz to 10-Hz Peak-to-Peak Noise Test Circuit and Frequency Response

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APPLICATION INFORMATION

noise testing (continued)

When measuring noise on a large number of units, a noise-voltage density test is recommended. A 10-Hz noise-voltage density measurement correlates well with a 0.1-Hz to 10-Hz peak-to-peak noise reading since both results are determined by the white noise and the location of the 1/f corner frequency.

Figure 27 shows a circuit measuring current noise and the formula for calculating current noise.

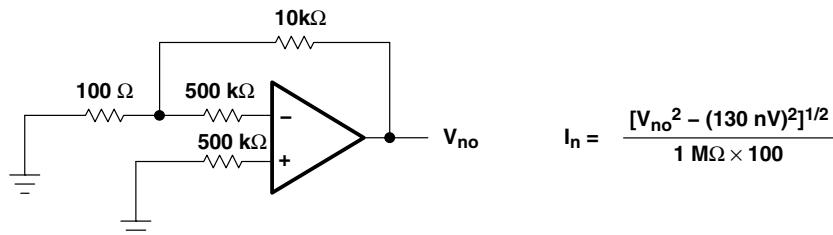


Figure 27. Current Noise Test Circuit and Formula

offset voltage adjustment

The input offset voltage and temperature coefficient of the OP27 are permanently trimmed to a low level at wafer testing. However, if further adjustment of V_{IO} is necessary, using a 10-kΩ nulling potentiometer as shown in Figure 28 does not degrade the temperature coefficient α_{VIO} . Trimming to a value other than zero creates an α_{VIO} of $V_{IO}/300 \mu\text{V}/^\circ\text{C}$. For example, if V_{IO} is adjusted to 300 μV , the change in α_{VIO} is 1 $\mu\text{V}/^\circ\text{C}$.

The adjustment range with a 10-kΩ potentiometer is approximately $\pm 2.5 \text{ mV}$. If a smaller adjustment range is needed, the sensitivity and resolution of the nulling can be improved by using a smaller potentiometer in conjunction with fixed resistors. The example in Figure 29 has an approximate null range of $\pm 200 \mu\text{V}$.

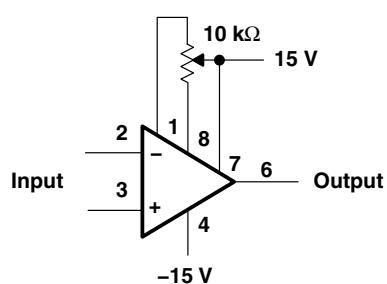


Figure 28. Standard Input Offset Voltage Adjustment

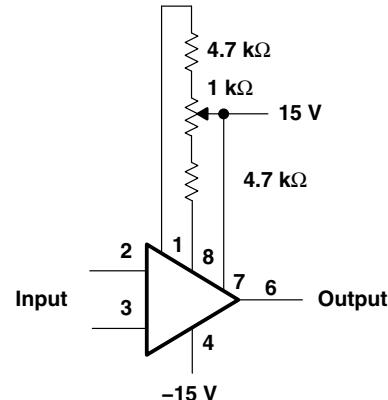


Figure 29. Input Offset Voltage Adjustment With Improved Sensitivity

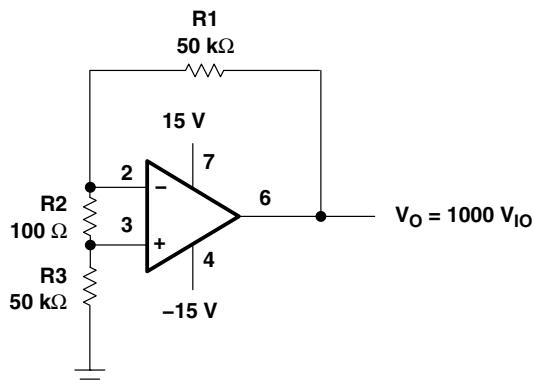
offset voltage and drift

Unless proper care is exercised, thermoelectric effects caused by temperature gradients across dissimilar metals at the contacts to the input terminals can exceed the inherent temperature coefficient α_{VIO} of the amplifier. Air currents should be minimized, package leads should be short, and the two input leads should be close together and at the same temperature.

APPLICATION INFORMATION

offset voltage and drift (continued)

The circuit shown in Figure 30 measures offset voltage. This circuit can also be used as the burn-in configuration for the OP27 with the supply voltage increased to 20 V, $R_1 = R_3 = 10 \text{ k}\Omega$, $R_2 = 200 \Omega$, and $A_{VD} = 100$.



NOTE A: Resistors must have low thermoelectric potential.

Figure 30. Test Circuit for Offset Voltage and Offset Voltage Temperature Coefficient

unity gain buffer applications

The resulting output waveform, when $R_f \leq 100 \Omega$ and the input is driven with a fast large-signal pulse (>1 V), is shown in the pulsed-operation diagram in Figure 31.



Figure 31. Pulsed Operation

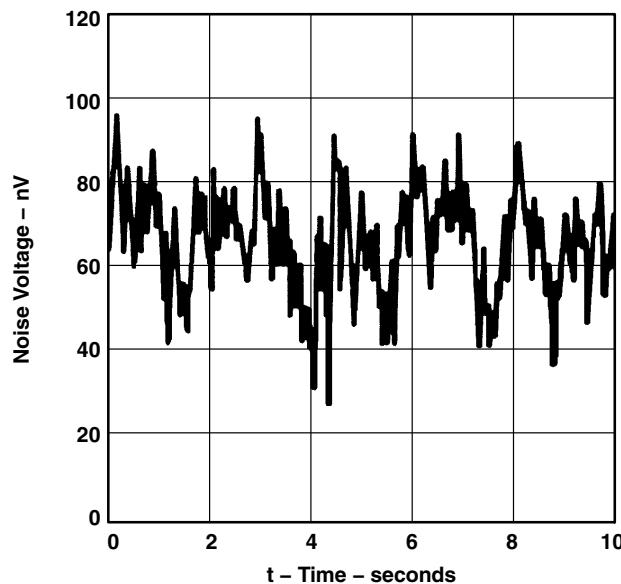
During the initial (fast-feedthrough-like) portion of the output waveform, the input protection diodes effectively short the output to the input, and a current, limited only by the output short-circuit protection, is drawn by the signal generator. When $R_f \geq 500 \Omega$, the output is capable of handling the current requirements (load current $\leq 20 \text{ mA}$ at 10 V), the amplifier stays in its active mode, and a smooth transition occurs. When $R_f > 2 \text{ k}\Omega$, a pole is created with R_f and the amplifier's input capacitance, creating additional phase shift and reducing the phase margin. A small capacitor (20 pF to 50 pF) in parallel with R_f eliminates this problem.

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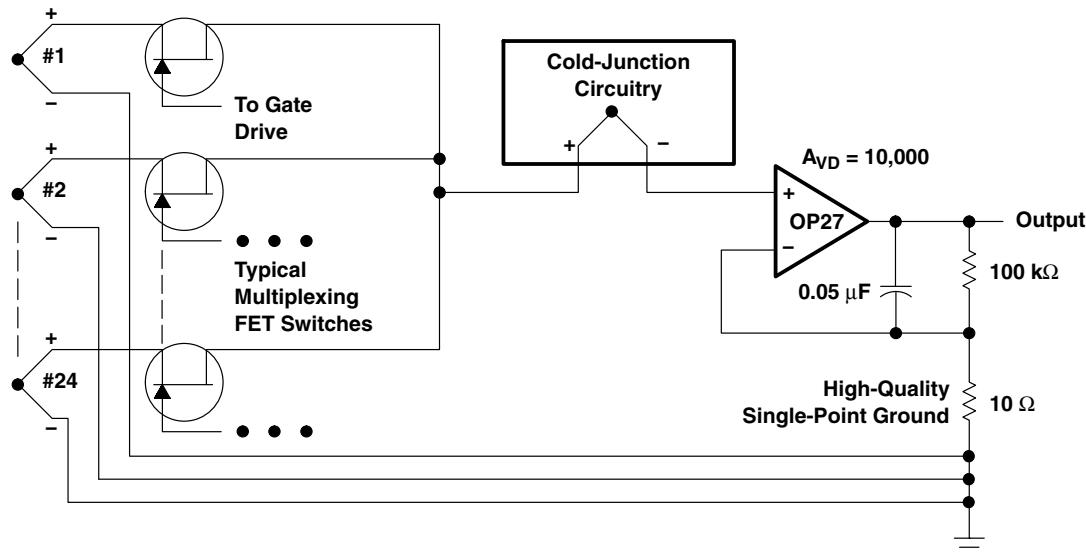
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APPLICATION INFORMATION

unity gain buffer applications (continued)



Type S Thermocouples
5.4 μ V/ $^{\circ}$ C at 0 $^{\circ}$ C



NOTE A: If 24 channels are multiplexed per second and the output is required to settle to 0.1 % accuracy, the amplifier's bandwidth cannot be limited to less than 30 Hz. The peak-to-peak noise contribution of the OP27 will still be only 0.11 μ V, which is equivalent to an error of only 0.02 $^{\circ}$ C.

**Figure 32. Low-Noise, Multiplexed Thermocouple Amplifier and
0.1-Hz to 10-Hz Peak-to-Peak Noise Voltage**

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
JM38510/13506BPA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510 /13506BPA
JM38510/13506BPA.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510 /13506BPA
OP27AFKB	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-	OP27AFKB
OP27AFKB.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	OP27AFKB
OP27AJGB	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-	OP27AJGB
OP27AJGB.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	OP27AJGB
OP27CJGB	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-	OP27CJGB
OP27CJGB.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	OP27CJGB

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

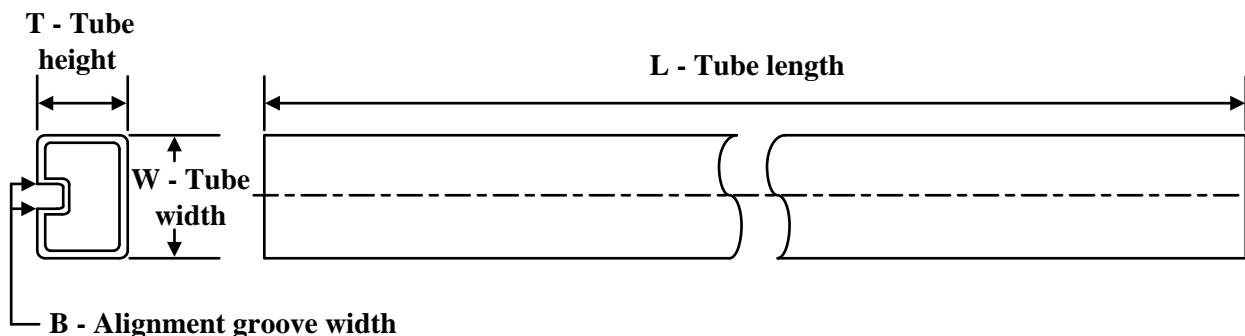
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE


*All dimensions are nominal

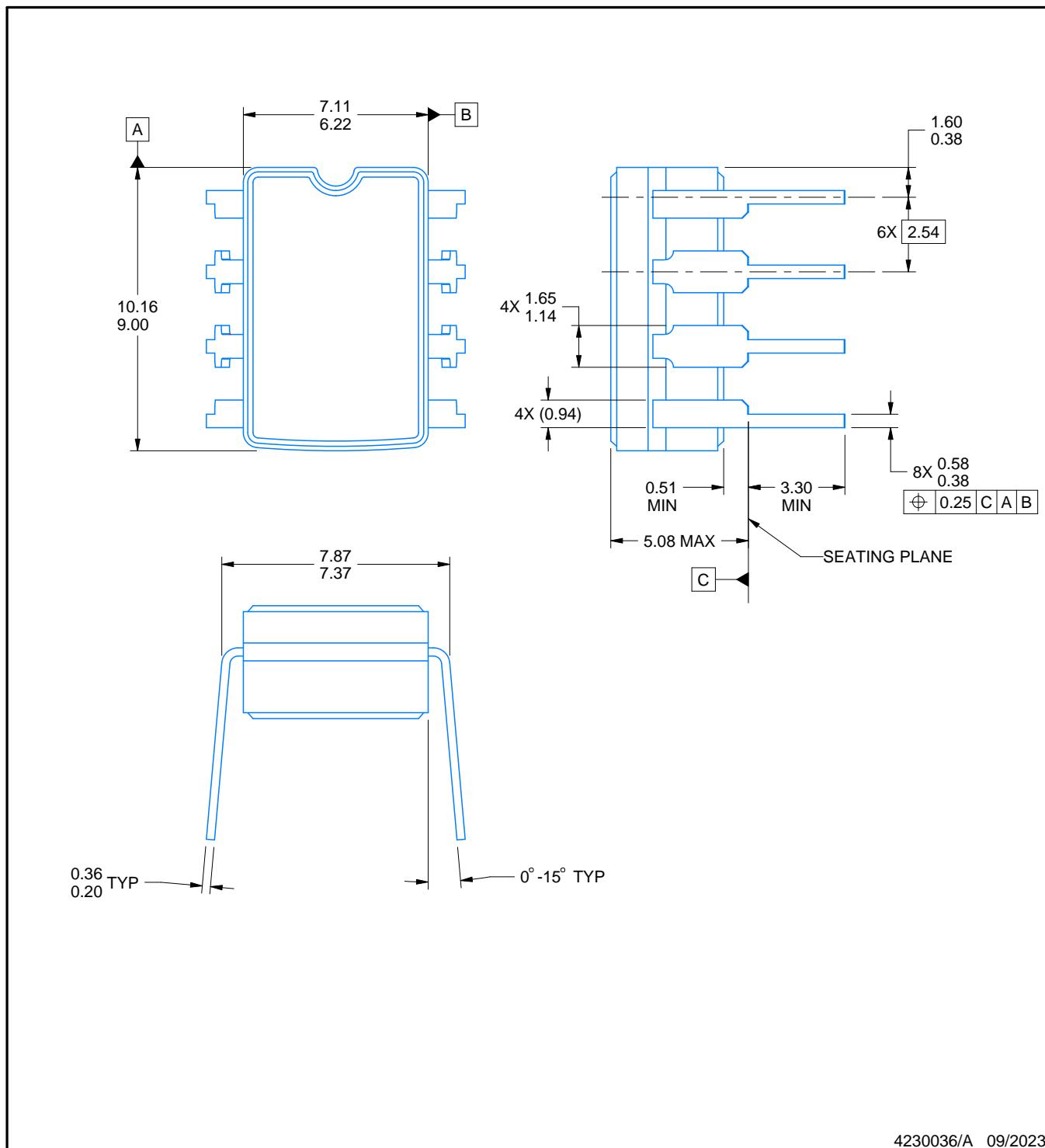
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μ m)	B (mm)
OP27AFKB	FK	LCCC	20	55	506.98	12.06	2030	NA
OP27AFKB.A	FK	LCCC	20	55	506.98	12.06	2030	NA

PACKAGE OUTLINE

JG0008A

CDIP - 5.08 mm max height

CERAMIC DUAL IN-LINE PACKAGE



4230036/A 09/2023

NOTES:

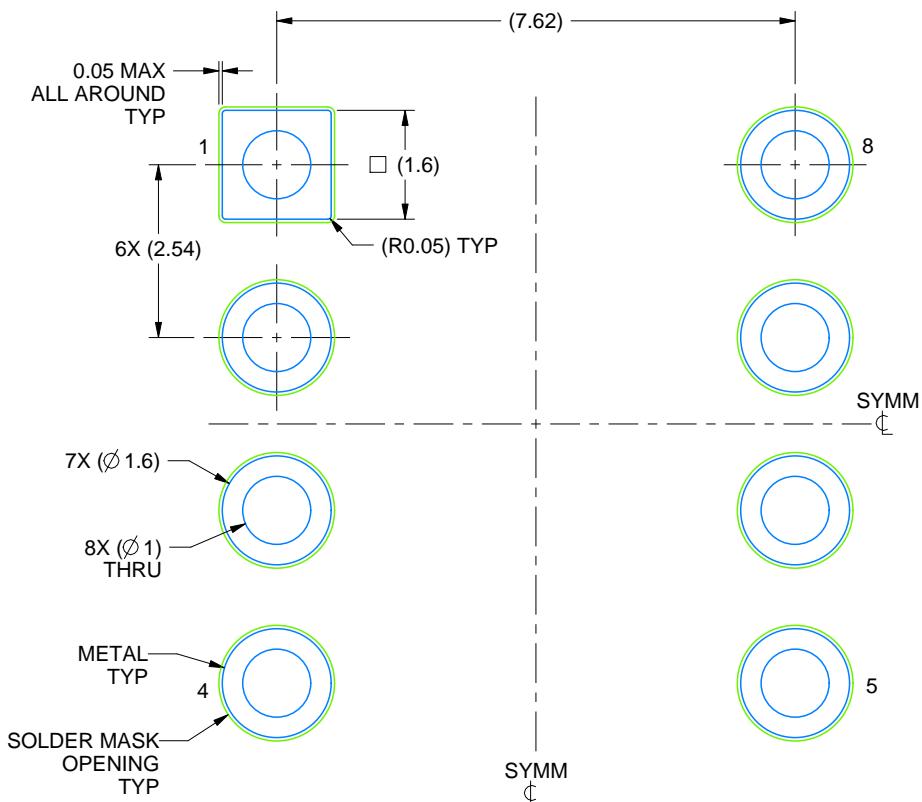
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package can be hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification.
5. Falls within MIL STD 1835 GDIP1-T8

EXAMPLE BOARD LAYOUT

JG0008A

CDIP - 5.08 mm max height

CERAMIC DUAL IN-LINE PACKAGE



LAND PATTERN EXAMPLE
NON SOLDER MASK DEFINED
SCALE: 9X

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GENERIC PACKAGE VIEW

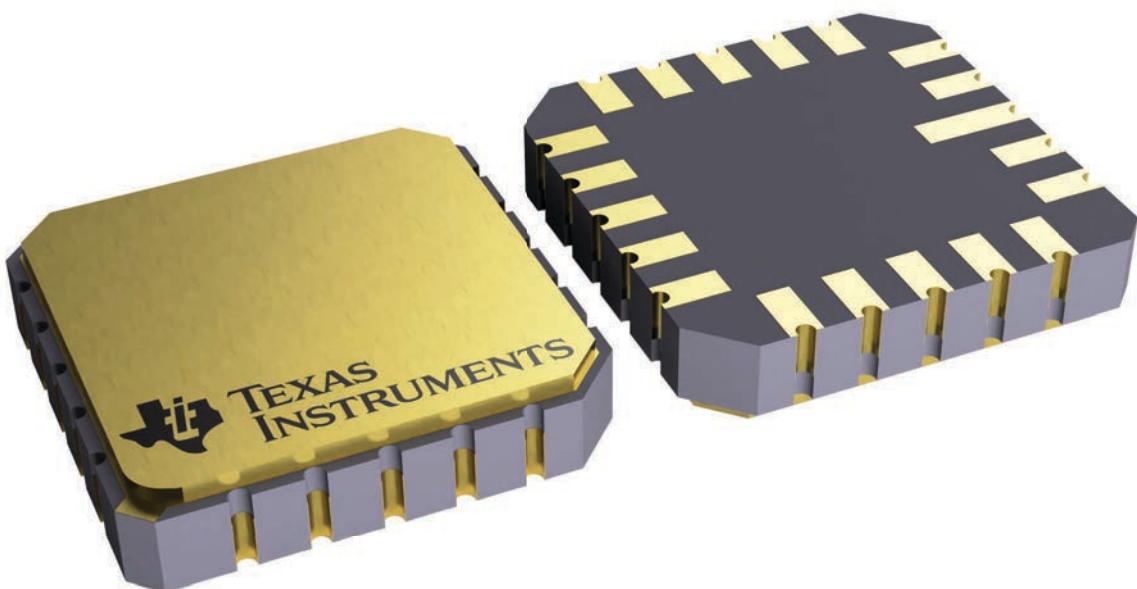
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



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